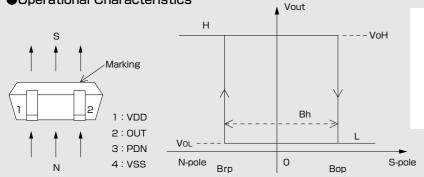
EM-1712

Shipped in packet-tape reel(5000pcs/Reel)

EM-1712 is ultra-small Hall effect ICs of a single silicon chip composed of Hall element and a signal processing IC.

| Bipolar Hall Effect Latch | Supply Voltage 1.6~5.5V | Power down Function | Ultra High Sensitivity Bop: 1.8mT | Output CMOS | SMT | |
|------------------------------|----------------------------|------------------------|---|------------------------|-----|--|
| Notice: It is requested to | o read and accept "IMPOF | TANT NOTICE" written | on the back of the front co | over of this catalogue | 9. | |

Operational Characteristics





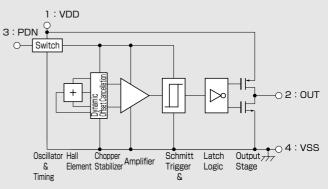
Magnetic flux density ●Absolute Maximum Ratings (Ta=25℃)

| Item | Symbol | Limit | Unit | |
|-----------------------------|-----------------|-----------------|------|--|
| Supply Voltage | VDD | $-0.1 \sim 6.0$ | V | |
| PDN input voltage | V _{in} | -0.1 ~ VDD+0.1 | V | |
| PDN input current | Iin | ±10 | mA | |
| Output Current | Iout | ±0.5 | mA | |
| Operating Temperature Range | Topr | $-30 \sim +85$ | Ĉ | |
| Storage Temperature Range | Tstg | -40 ~ +125 | ĉ | |

●Magnetic ① and Electrical Characteristics (Ta=25°C VDD=3.0V)

| Item | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|---------------------------|-------------------|---------------|-----------|------|--------|------|
| Supply Voltage | VDD | | 1.6 | | 5.5 | V |
| Operating Point | B _{OP} | | | 1.8 | 4.0 | mT |
| Release Point | B _{rp} | | -4.0 | -1.8 | | mT |
| Hysteresis | Bh | | | 3.6 | | mT |
| PDN input High voltage | VIH | | 0.7VDD | | | V |
| PDN input Low voltage | v_{IL} | | | | 0.3 | V |
| Output High Voltage | V _{ОН} | lo=-0.5mA | VDD - 0.4 | | | V |
| Output Low Voltage | V _{OL} | Io=+0.5mA | | | 0.4 | V |
| Supply Current1*2 | IDD1 | PDN=L | | | 1 | μA |
| Supply Current2*2 | IDD2 | PDN=H,Average | | 60 | 150 | μA |
| PDN input Current | Iin | | -1 | | 1 | μA |
| PDN mode transition time1 | T _{PD} 1 | Active→PDN | | | (36.6) | μsec |
| PDN mode transition time2 | T _{PD} 2 | PDN→Active | | | 100 | μsec |

Functional Block Diagram



| Item | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|-----------------------|------------------|------------|------|------|------|------|
| Pulse Drive Period | T _{PD3} | PDN=H | 0.5 | 1.0 | 1.5 | msec |
| PDN input Pluse Width | т _w | | 100 | | | μsec |
| Pulse Drive Time | T _{PD4} | PDN=H | 12.2 | 24.4 | 36.6 | μsec |

●Magnetic Characteristics ② (Ta=-30~+85°C VDD=3.0V)

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|-----------------|-----------------|------------|------|------|------|------|
| Operating Point | B _{OP} | | | 1.8 | 4.2 | mT |
| Release Point | B _{rp} | | -4.2 | -1.5 | | mT |
| Hysteresis | Bh | | | 3.6 | | mT |

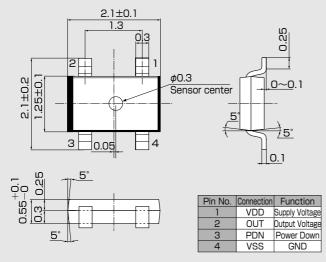
Note) The above specifications are design targets.

*1: Positive("+") polarity flux is defined as the magnetic flux from south pole which is direct toward to the branded face of the sensor (Bop,Brp) *2: In case of PDN pin is held at VDD or VSS. *3: This transition time is not guarantee 29

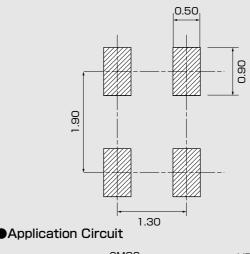
•Please be aware that our products are not intended for use in life support equipment, devices, or systems. Use of our products in such applications requires the advance written approval of our sales staff.

Certain applications using semiconductor devices may involve potential risks of personal injury, property damage, or loss of life. In order to minimize these risks, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards. Inclusion of our products in such applications is understood to be fully at the risk of the customer using our devices or systems.

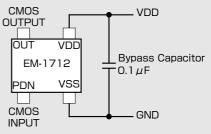
Package (Unit:mm)

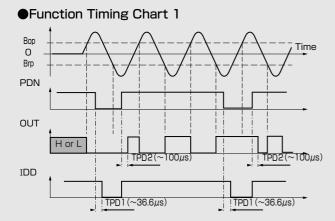


- Note1) The sensor center is located within the ϕ 0.3mm circle. Note2) The tolerances of dimensions
- with no mentions is ± 0.1 mm.
- Note3) Coplanarity:The differnces between
- standoff of terminals are max.0.1mm. Note4) The sensor part is located 0.4mm(typ.) far from marking surface.

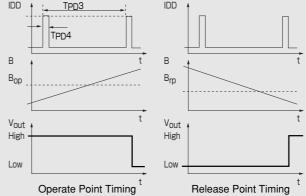


●(For reference only)Land Pattern (Unit:mm)



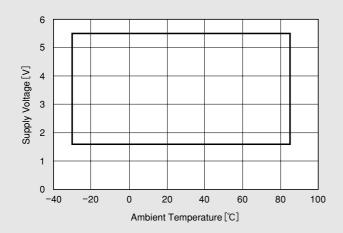


Function Timing Chart 2 (PDN=H) IDD + TPD3 IDD +

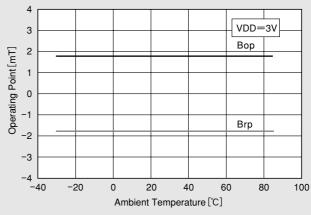


Note1) In power down mode, Output is kept current status. Note2) When VDD is supplied ,output settling time after power supply voltage exceeds 1.6V is equal to TPD2.

Supply Voltage



Temparature Dependence of Bop. Brp



IMPORTANT NOTICE

- These products and their specifications are subject to change without notice. When you consider any use or application of these products, please make inquiries the sales office of Asahi Kasei EMD Corporation (AKEMD) or authorized distributors as to current status of the products.
- AKEMD assumes no liability for infringement of any patent, intellectual property, or other rights in the application or use of any information contained herein.
- Any export of these products, or devices or systems containing them, may require an
 export license or other official approval under the law and regulations of the country of
 export pertaining to customs and tariffs, currency exchange, or strategic materials.
- AKEMD products are neither intended nor authorized for use as critical components_{Note1} in any safety, life support, or other hazard related device or system_{Note2}, and AKEMD assumes no responsibility for such use, except for the use approved with the express written consent by AKEMD. As used here:

Note1) A critical component is one whose failure to function or perform may reasonably be expected to result, whether directly or indirectly, in the loss of the safety or effectiveness of the device or system containing it, and which must therefore meet very high standards of performance and reliability.

Note2) A hazard related device or system is one designed or intended for life support or maintenance of safety or for applications in medicine, aerospace, nuclear energy, or other fields, in which its failure to function or perform may reasonably be expected to result in loss of life or in significant injury or damage to person or property.

person or property.
 It is the responsibility of the buyer or distributor of AKEMD products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the above content and conditions, and the buyer or distributor agrees to assume any and all responsibility and liability for and hold AKEMD harmless from any and all claims arising from the use of said product in the absence of such notification.

ASAHI KASEI EMD CORPORATION

Headquaters

1-23-7 Nishi-Shinjyuku, Shinjyuku-ku, Tokyo 160-0023, Japan TEL: +81-3-6911-2800 FAX: +81-3-6911-2815

Osaka Office

1-2-6 Dojimahama Kita-ku,Osaka 530-8205,Japan

TEL. +81-6-6347-3133 FAX.+81-3-6911-2815

Europe Office

Market House, 19/21 Market Place, Wokingham, Berkshire, RG40 1AP, U.K.

TEL: +44-118-979-5777 FAX: +44-118-979-7885

Shanghai Office

Room2321,Shanghai Central Plaza,381 Huaihai Zhong Road,Shanghai 200020,Chaina TEL. +86-21-6391-6111 FAX.+86-21-6391-6686

Seoul Office

8th fi.,KTP B/D,27-2 Yoido-dong,Youngdungpo-gu,Seoul 150-742,Korea TEL. +82-2-3775-0990 FAX.+82-2-3775-1991

AKM Semiconductor,Inc

Western US Sales

1731 Technology Dr Suito 500 San Jose,CA95110,USA TEL. +1-408-436-8580 FAX.+1-408-436-7591 Eastern US Sales 629 Bamford Road Cherry Hill,NJ 08003,USA TEL. +1-856-424-7211 FAX.+1-856-424-7344

URL

http://www.akemd.com

North American Distributor: GMW Associates

 955 Industrial Rd, San Carlos, CA 94070, USA

 TEL. +1-650-802-8292
 FAX. +1-650-802-8298

 EMAIL sales@gmw.com
 WEB www.gmw.com